

## Surface-Mount Ultrafast Avalanche Rectifiers

### eSMP® Series



Top view Bottom view

### SMF (DO-219AB)



### LINKS TO ADDITIONAL RESOURCES



### FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Ultrafast recovery times for high frequency
- Low reverse current
- Meets MSL level 1, per J-STD-020; LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified
  - Automotive ordering code: base P/NHM3
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



RoHS  
COMPLIANT  
HALOGEN  
FREE

### TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

### MECHANICAL DATA

#### Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating  
 Base P/N-M3 - halogen-free, RoHS-compliant  
 Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.0 A
$V_{RRM}$	200 V, 400 V, 600 V, 800 V, 1000 V
$I_{FSM}$	30 A, 25 A
$t_{rr}$	75 ns
$I_R$	1 $\mu$ A
$V_F$ at $I_F = 1$ A	1.4, 1.6 V
$E_{AS}$	20 mJ
$T_J$ max.	175 °C
Package	SMF (DO-219AB)
Circuit configuration	Single

MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)							
PARAMETER	SYMBOL	AU1FD	AU1FG	AU1FJ	AU1FK	AU1FM	UNIT
Device marking code		AUD	AUG	AUJ	AUK	AUM	
Max. repetitive peak reverse voltage	$V_{RRM}$	200	400	600	800	1000	V
Average forward current	$I_{F(AV)}$	1					A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	30		25			A
Non-repetitive avalanche energy at $I_{AS} = 1.0$ A, $T_A = 25$ °C	$E_{AS}$	20					mJ
Operating junction and storage temperature range	$T_J, T_{STG}$	-55 to +175					°C



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted)									
PARAMETER	TEST CONDITIONS	SYMBOL	AU1FD	AU1FG	AU1FJ	AU1FK	AU1FM	UNIT	
Maximum instantaneous forward voltage	$I_F = 1.0\text{ A}$	$V_F^{(1)}$	$T_J = 25\text{ }^\circ\text{C}$		1.5		1.85		V
			$T_J = 125\text{ }^\circ\text{C}$		1.4		1.6		
Maximum reverse current	Rated $V_R$	$I_R^{(2)}$	$T_J = 25\text{ }^\circ\text{C}$		1				$\mu\text{A}$
			$T_J = 125\text{ }^\circ\text{C}$		100				
Maximum reverse recovery time	$I_F = 0.5\text{ A}, I_R = 1.0\text{ A}, I_{rr} = 0.25\text{ A}$	$t_{rr}$	75				ns		
Typical junction capacitance	4.0 V, 1 MHz	$C_J$	12.2			8.2		pF	

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle
- (2) Pulse test: Pulse width  $\leq 40\text{ ms}$

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)								
PARAMETER	SYMBOL	AU1FD	AU1FG	AU1FJ	AU1FK	AU1FM	UNIT	
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	130				$^\circ\text{C/W}$		
	$R_{\theta JM}^{(1)}$	20						

**Notes**

- (1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount
- (2) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
AU1FM-M3/H	0.0145	H	3000	7" diameter plastic tape and reel
AU1FM-M3/I	0.0145	I	10 000	13" diameter plastic tape and reel
AU1FMHM3/H <sup>(1)</sup>	0.0145	H	3000	7" diameter plastic tape and reel
AU1FMHM3/I <sup>(1)</sup>	0.0145	I	10 000	13" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified



## RATINGS AND CHARACTERISTICS CURVES ( $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

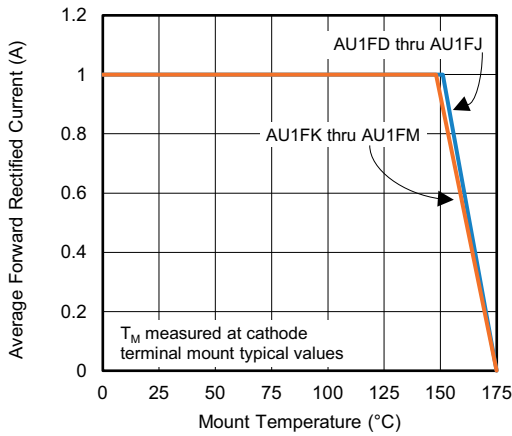


Fig. 1 - Maximum Forward Current Derating Curve

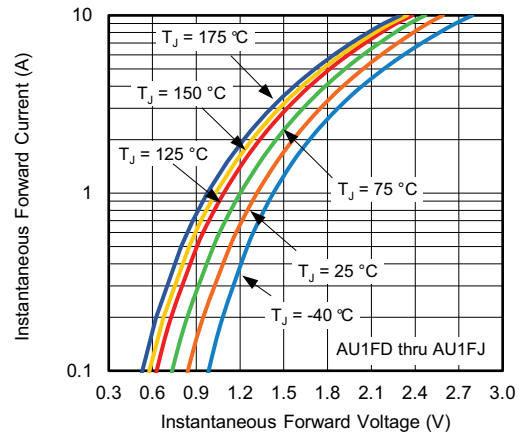


Fig. 4 - Typical Instantaneous Forward Characteristics

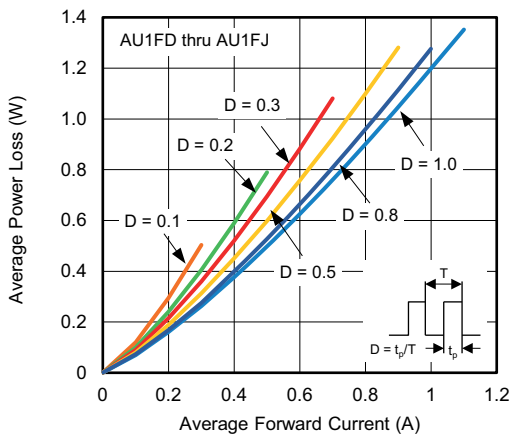


Fig. 2 - Forward Power Loss Characteristics

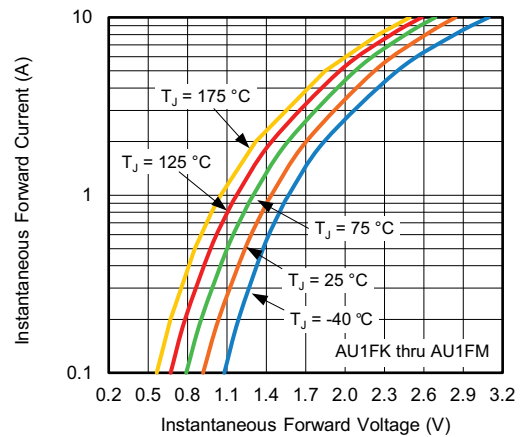


Fig. 5 - Typical Instantaneous Forward Characteristics

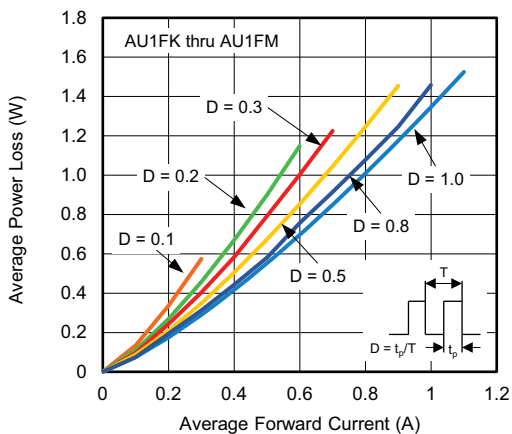


Fig. 3 - Forward Power Loss Characteristics

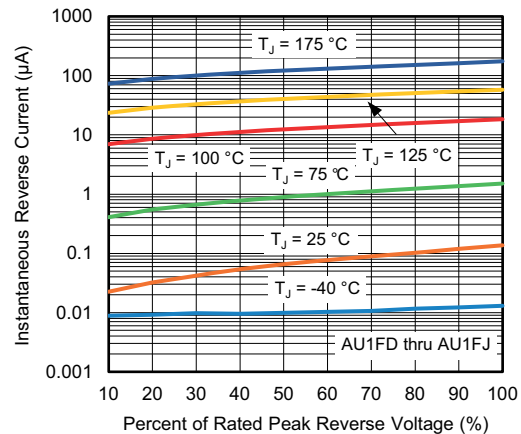


Fig. 6 - Typical Reverse Characteristics

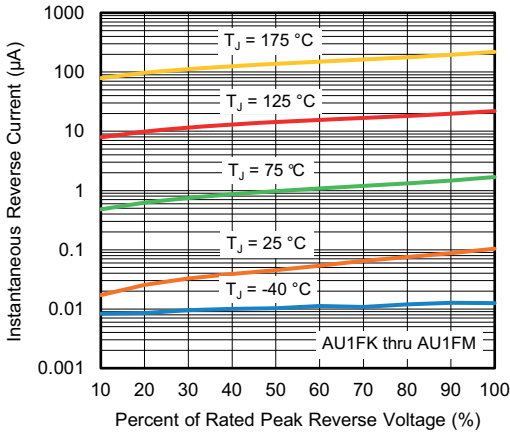


Fig. 7 - Typical Reverse Characteristics

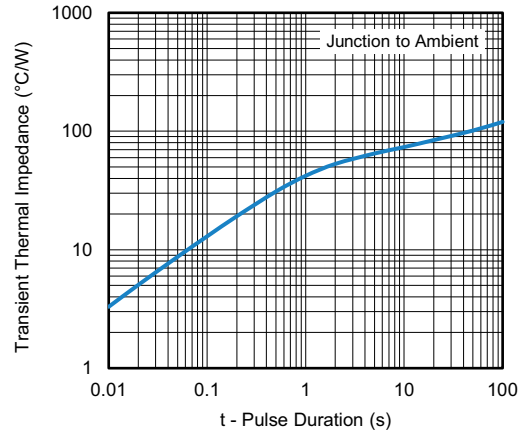


Fig. 9 - Typical Transient Thermal Impedance

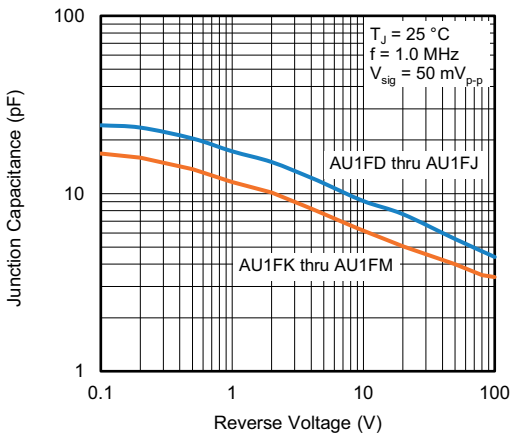
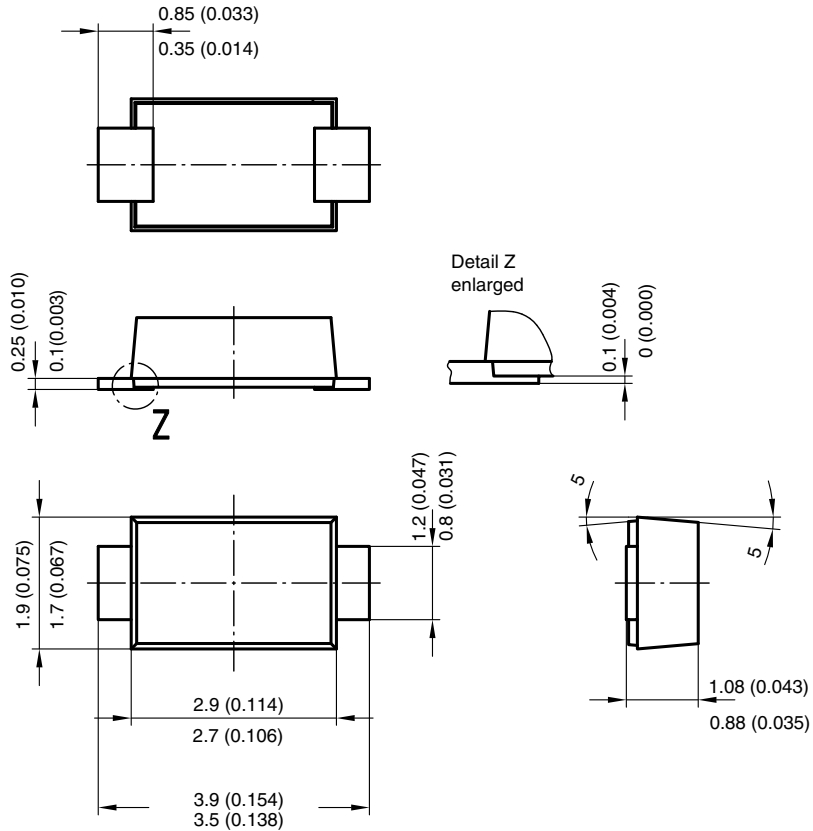


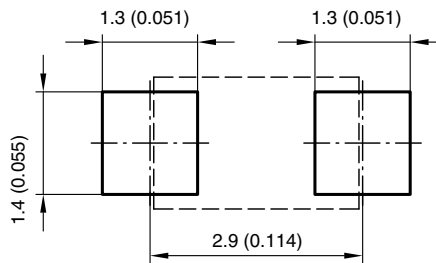
Fig. 8 - Typical Junction Capacitance



## PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



Created - Date: 15. February 2005  
Rev. 3 - Date: 13. March 2007  
Document no.: S8-V-3915.01-001 (4)  
17247



## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.